



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	BV _{DSS}	R _{DS(ON)} max	I _D max T _A = +25°C	
04		$25m\Omega$ @ V _{GS} = 4.5V	6.0A	
Q1 N-Channel	12V	$30m\Omega$ @ V _{GS} = 3.3V	5.5A	
N-Charmer		$32m\Omega$ @ $V_{GS} = 2.5V$	5.3A	
00		$80m\Omega @ V_{GS} = -4.5V$	-3.4A	
Q2 P-Channel	-20V	-20V 90mΩ @ V _{GS} = -3.3V		-3.2A
1 - Onamici		100mΩ @ V _{GS} = -2.5V	-3.0A	

Features

- Low On-Resistance
- Low Input Capacitance
- Low Profile, 0.6mm Max Height
- ESD HBM Protected up to 1.5kV, MM Protected up to 150V
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Description

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

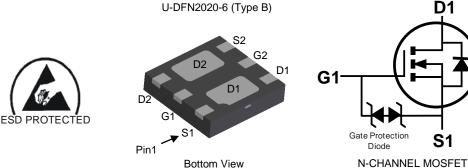
Applications

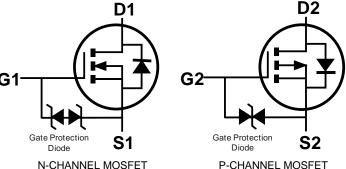
Optimized for Point of Load (POL) Synchronous Buck Converter that steps down from 3.3V to 1V for core voltage supply to ASICs. Target applications are Ethernet Network Controllers used in:

- Routers, Switchers, Network Interface Controllers (NICs)
- Digital Subscriber Line (DSL)
- Set-Top Boxes (STBs)

Mechanical Data

- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 4
- Terminals Connections: See Diagram Below
- Weight: 0.0065 grams (Approximate)





Internal Schematic

Ordering Information (Note 4)

Part Number	Case	Packaging
DMC1028UFDB-7	U-DFN2020-6 (Type B)	3,000/Tape & Reel
DMC1028UFDB-13	U-DFN2020-6 (Type B)	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information

Site 1



D8 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: H = 2020) M = Month (ex: 9 = September)

Date Code Key

Year	2014		2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	В		Н		J	K	L	M	N	0	Р	R
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

Site 2



D8 = Product Type Marking Code
YWX = Date Code Marking
Y = Year (ex: 0 = 2020)
W = Week (ex: a = Week 27; z Represents Week 52 and 53)
X = Internal Code (ex: U = Monday)

Date Code Key

Year	2014		2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	4		0	1	2	3	4	5	6	7	8	9
Week	ek 1-26			27-52				53				
Code		Α	-Z		a-z			Z				
Internal Code	Sur	1	Mon		Tue	W	ed	Thu		Fri	,	Sat
Code	T		U		V	V	٧	Х		Υ		Z



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Q1 N-CHANNEL	Q2 P-CHANNEL	Unit		
Drain-Source Voltage			VDSS	12	-20	V
Gate-Source Voltage			Vgss	±8	±8	V
Continuous Drain Current (Note 5) N-Channel: V _{GS} = 4.5V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I _D	6.0 4.8	-3.4 -2.7	А
P-Channel: V _{GS} = 4.5V	t < 5s	T _A = +25°C T _A = +70°C	ID	7.1 5.7	-4.0 -3.2	А
Maximum Continuous Body Diode Forward Cur	rent (Note 5)	Is	1.4	-1.4	А
Pulsed Drain Current (10µs Pulse, Duty Cycle =	I _{DM}	40	-20	Α		
Avalanche Current L = 0.1mH	las	12	-12	А		
Avalanche Energy L = 0.1mH			E _{AS}	8.4	7.5	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit		
Total Power Dissipation (Note 5)	Steady State	PD	1.36	W	
Total Fower Dissipation (Note 3)	t < 5s	FD	1.89	VV	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	92		
Thermal Resistance, Junction to Ambient (Note 5)	t < 5s		66	°C/W	
Thermal Resistance, Junction to Case (Note 5)	Rejc	19			
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C		

5. Device mounted on 1" \times 1" FR-4 PCB with high coverage 2oz. Copper, single sided. Note:

Electrical Characteristics Q1 N-CHANNEL (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)							
Drain-Source Breakdown Voltage	BVDSS	12	l	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	IDSS	l	I	1.0	μΑ	V _{DS} = 12V, V _{GS} = 0V	
Gate-Source Leakage	Igss	1	l	±10	μΑ	$V_{GS} = \pm 8V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	Vgs(TH)	0.4	_	1	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
		_	17	25		$V_{GS} = 4.5V, I_{D} = 5.2A$	
Static Drain-Source On-Resistance	Dag(a)	_	19	30	mΩ	$V_{GS} = 3.3V, I_{D} = 5.0A$	
Static Dialit-Source Off-Resistance	RDS(ON)	1	21	32	11122	$V_{GS} = 2.5V, I_{D} = 4.8A$	
			30	40		$V_{GS} = 1.8V, I_D = 2.5A$	
Diode Forward Voltage	VsD	_	0.7	1.2	V	V _G S = 0V, I _S = 1A	
DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	Ciss	l	787		pF	\/	
Output Capacitance	Coss	_	203	_	pF	$V_{DS} = 6V, V_{GS} = 0V,$ -f = 1.0MHz	
Reverse Transfer Capacitance	Crss		177	_	pF	1 = 1.001112	
Gate Resistance	Rg	_	4.8	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 3.3V)		_	7.9	_	nC		
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	10.5	_	nC		
Total Gate Charge (Vgs = 8V)		_	18.5	_	nC	$V_{DS} = 6V, I_{D} = 6.8A$	
Gate-Source Charge	Qgs	_	1.2	_	nC		
Gate-Drain Charge	Q _{gd}	_	2.9	_	nC]	
Turn-On Delay Time	t _{D(ON)}	_	4.6	_	ns		
Turn-On Rise Time	t _R	_	9.4	_	ns	$V_{DD} = 6V, V_{GS} = 4.5V,$	
Turn-Off Delay Time	tD(OFF)	_	15.7	_	ns	$R_L = 1.1\Omega$, $R_G = 1\Omega$	
Turn-Off Fall Time	t _F	_	3.7	_	ns]	
Body Diode Reverse Recovery Time	trr	_	12.0	_	ns	Is = 5.4A, dI/dt = 100A/µs	
Body Diode Reverse Recovery Charge	Q _{RR}	_	1.8		nC	I _S = 5.4A, dI/dt = 100A/µs	

6. Short duration pulse test used to minimize self-heating effect. 7. Guaranteed by design. Not subject to product testing. Notes:

DMC1028UFDB Document number: DS37634 Rev. 5 - 2



Electrical Characteristics Q2 P-CHANNEL (@TA = +25°C, unless otherwise specified.)

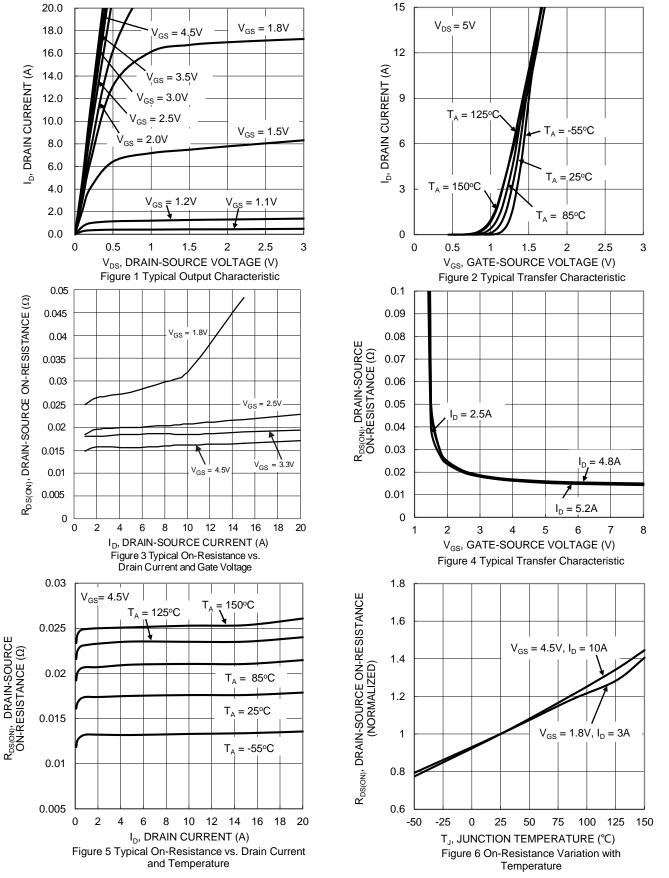
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)	- J		. 76		•		
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	IDSS	_		-1.0	μA	V _{DS} = -20V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_		±10	μA	$V_{GS} = \pm 8V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	V _{GS(TH)}	-0.4	1	-1	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	
			55	80		$V_{GS} = -4.5V$, $I_{D} = -3.8A$	
			63	90		$V_{GS} = -3.3V$, $I_{D} = -3.5A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	70	100	mΩ	$V_{GS} = -2.5V$, $I_{D} = -3.3A$	
		_	88	140		$V_{GS} = -1.8V, I_{D} = -1.0A$	
		_	110	210		$V_{GS} = -1.5V, I_{D} = -0.5A$	
Diode Forward Voltage	VsD	_	-0.7	-1.2	V	$V_{GS} = 0V$, $I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	Ciss	_	576	_	pF	101/11/	
Output Capacitance	Coss	_	87	_	pF	V _{DS} = -10V, V _{GS} = 0V, -f = 1.0MHz	
Reverse Transfer Capacitance	Crss		71		рF	1 = 1.01/11/12	
Gate Resistance	Rg	_	15	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (Vgs = -3.3V)			5.2		nC		
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	6.7	_	nC		
Total Gate Charge (V _{GS} = -8V)		_	11.5	_	nC	$V_{DS} = -10V, I_{D} = -4.9A$	
Gate-Source Charge	Qgs	_	1.0	_	nC		
Gate-Drain Charge	Qgd	_	2.0	_	nC		
Turn-On Delay Time	td(on)	_	3.5	_	ns		
Turn-On Rise Time	t _R	_	3.6	_	ns	$V_{DD} = -10V, V_{GS} = -4.5V,$	
Turn-Off Delay Time	tD(OFF)	_	20.8	_	ns	$R_L = 2.6\Omega$, $R_G = 1\Omega$	
Turn-Off Fall Time	t _F	_	12.7	_	ns		
Body Diode Reverse Recovery Time	trr		13.1		ns	Is = -3.9A, dI/dt = 100A/µs	
Body Diode Reverse Recovery Charge	Qrr	_	3.9	_	nC	Is = -3.9A, dI/dt = 100A/µs	

Notes:

^{6.} Short duration pulse test used to minimize self-heating effect. 7. Guaranteed by design. Not subject to product testing.



Typical Characteristics - N-CHANNEL





Typical Characteristics - N-CHANNEL (continued)

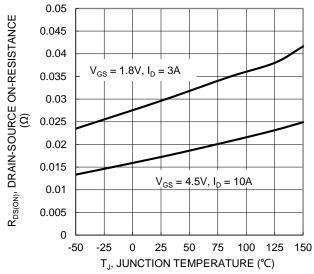


Figure 7 On-Resistance Variation with Temperature

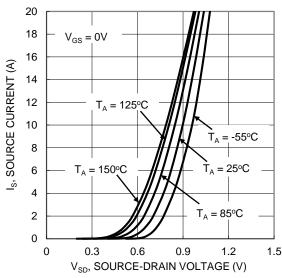
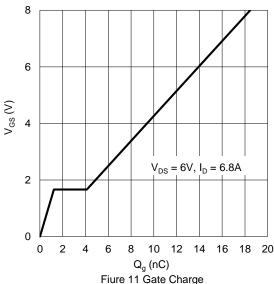
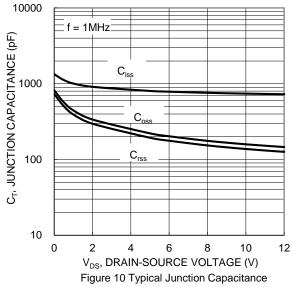


Figure 9 Diode Forward Voltage vs. Current



1.2 $V_{GS(TH)}$, GATE THRESHOLD VOLTAGE (V) 1.1 1 0.9 8.0 $I_D = 1mA$ 0.7 0.6 0.5 $I_{D} = 250 \mu A$ 0.4 0.3 0.2 0.1 0 50 75 100 125 T_J , JUNCTION TEMPERATURE (°C)

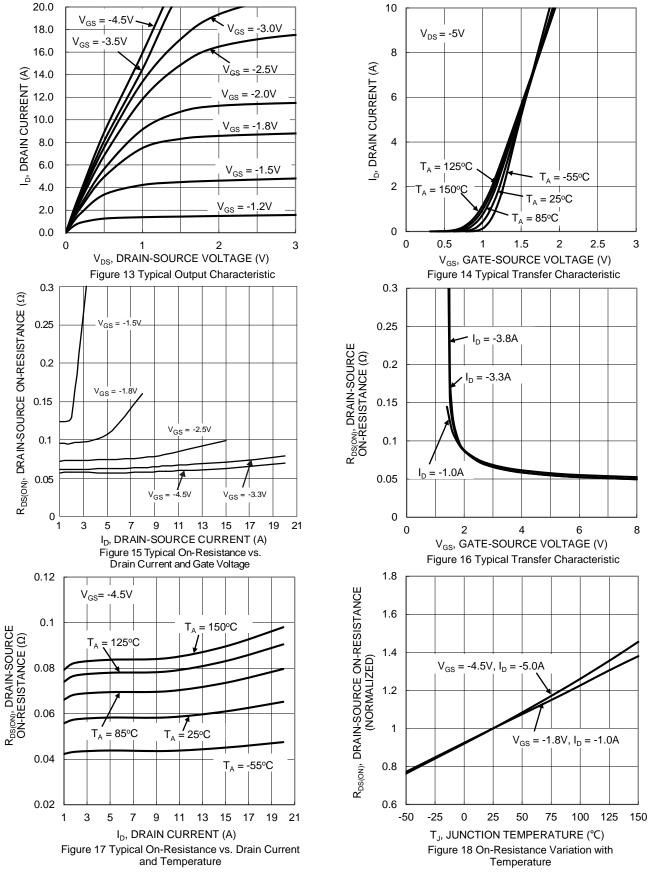
Figure 8 Gate Threshold Variation vs. Junction Temperature



100 R_{DS(ON)} Limited 10 ID, DRAIN CURRENT (A) $P_W = 10s$ $T_{J(Max)} = 150^{\circ}C P_W$ $T_A = 25^{\circ}C$ =100ms 0.1 $V_{GS} = 4.5V$ P_w =10ms Single Pulse =1ms DUT on 1*MRP || P_W =100μs Board 0.01 100 0.01 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12 SOA, Safe Operation Area

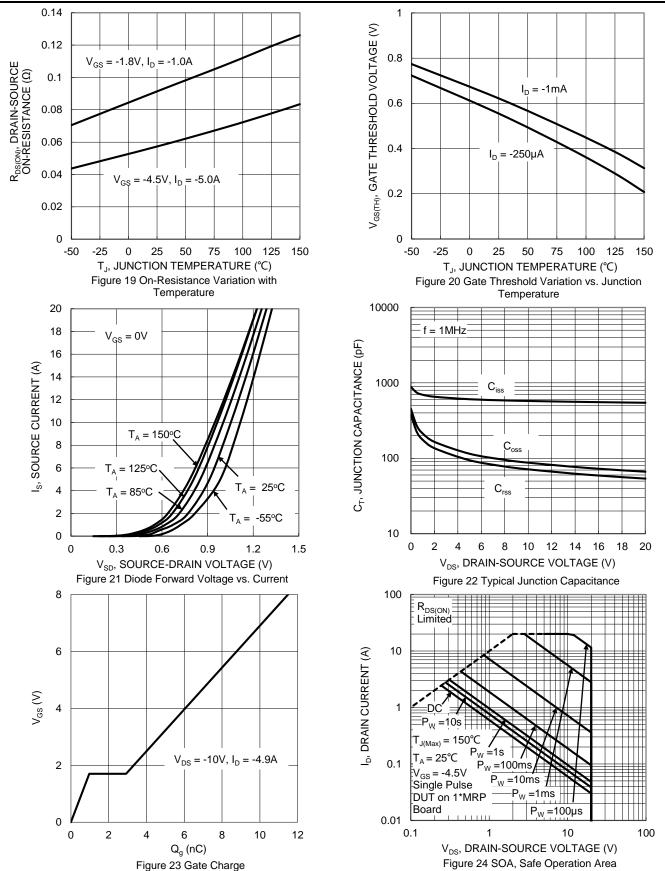


Typical Characteristics - P-CHANNEL





Typical Characteristics - P-CHANNEL (continued)





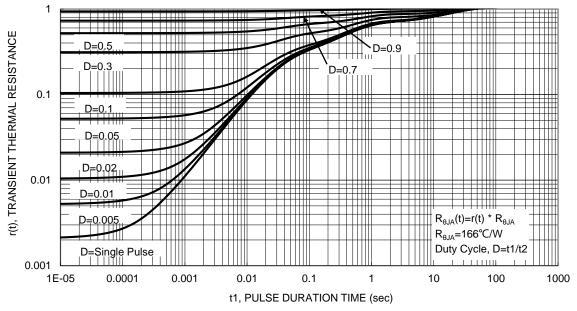
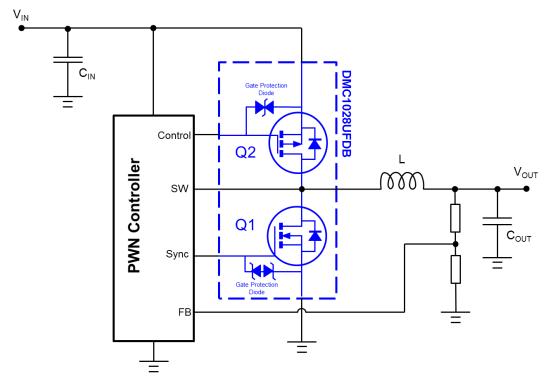


Figure 25 Transient Thermal Resistance

Typical Application Circuit



Example of a 3.3V to 1V POL Buck Converter using the DMC1028UFDB

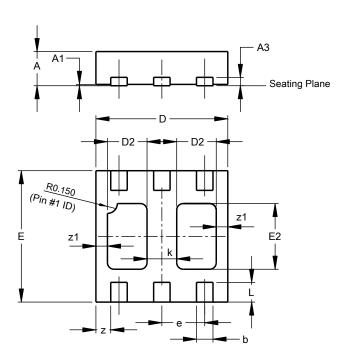
DMC1028UFDB is designed for Point-of-Load (POL) converter that is stepping down from a nominal 3.3V to 1V with a load current up to 3A. This is implemented with a separate ASIC that is PWM signaling the complementary MOSFETs to act as a synchronous buck converter. The control switch (Q2) is implemented with P-channel MOSFETs to avoid needing a charge pump and with the 3.3V to 1V step down, which has a duty cycle of 33%. This means that for 67% of the cycle, the synchronous switch (Q1) is on and efficiency is dominated by the conduction losses; hence, the need for low R_{DS(ON)} N-channel MOSFETs. Whereas for the control switch (Q2), the gate charge needs to be minimized as the switching losses become significant.



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type B)

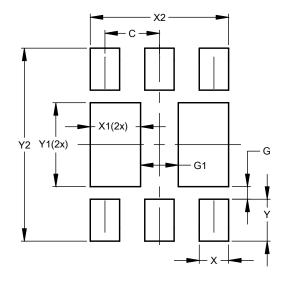


U-DFN2020-6								
Type B								
Dim	Min	Max	Тур					
Α	0.545	0.605	0.575					
A1	0.00	0.05	0.02					
A3		-	0.13					
b	0.20	0.30	0.25					
D	1.95	2.075	2.00					
D2	0.50	0.70	0.60					
е	-	-	0.65					
Е	1.95	2.075	2.00					
E2	0.90	1.10	1.00					
k	-	-	0.45					
L	0.25	0.35	0.30					
z	-	-	0.225					
z1	-	-	0.175					
All I	Dimens	ions in	mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type B)



Dimensions	Value (in mm)
С	0.650
	0.050
G	0.150
G1	0.450
Х	0.350
X1	0.600
X2	1.650
Υ	0.500
Y1	1.000
Y2	2 300



IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
 - 1. are intended to implant into the body, or
 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2020, Diodes Incorporated

www.diodes.com

DMC1028UFDB 11 of 11
Document number: DS37634 Rev. 5 - 2 Downloaded From Oneyac.com

单击下面可查看定价,库存,交付和生命周期等信息

>>Diodes Incorporated(达迩科技(美台))